

## Electronic Patent Application Fee Transmittal

Application Number:	10688452			
Filing Date:	18-Oct-2003			
Title of Invention:	Stacked interconnect structure between copper lines of a semiconductor circuit			
First Named Inventor/Applicant Name:	Stephan Grunow			
Filer:	Jacqueline J. Garner.			
Attorney Docket Number:	TI-35917			
Filed as Large Entity				
<b>Utility Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				
Extension - 3 months with \$0 paid	1253	1	1050	1050

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>1050</b>